

# SW63-4G



Extruded heat sink with unequal channel widths and device mounting holes

This non-electronic component is functionally unaffected by the normal soldering or reflow processes used for semiconductor circuits. The heat resistance time or heat resistance temperature is not applicable for the component.

Height:	62.99
Mount Orientation:	Vertical
Finish:	Black Anodize
RoHS:	Compliant
Thermal Resistance:	7.00
Additional Drawing Dimensions:	A: 63

